# 74AHC14-Q100; 74AHCT14-Q100

## Hex inverting Schmitt trigger

Rev. 1 — 9 July 2012

**Product data sheet** 

## 1. General description

The 74AHC14-Q100; 74AHCT14-Q100 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7A.

The 74AHC14-Q100; 74AHCT14-Q100 provides six inverting buffers with Schmitt trigger action. They are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Balanced propagation delays
- All inputs have Schmitt trigger actions
- Inputs accept voltages higher than V<sub>CC</sub>
- Input levels:
  - ◆ For 74AHC14-Q100: CMOS level
  - ◆ For 74AHCT14-Q100: TTL level
- ESD protection:
  - ◆ MIL-STD-883, method 3015 exceeds 2000 V
  - ♦ HBM JESD22-A114F exceeds 2000 V
  - ♦ MM JESD22-A115-A exceeds 200 V (C = 200 pf, R = 0 Ω)
- Multiple package options

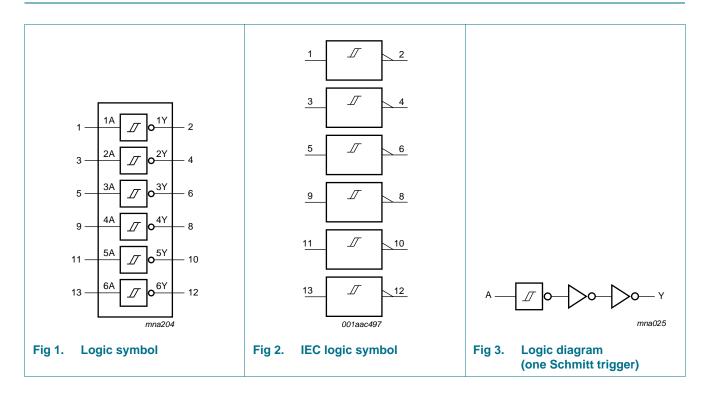


## 3. Ordering information

Table 1. Ordering information

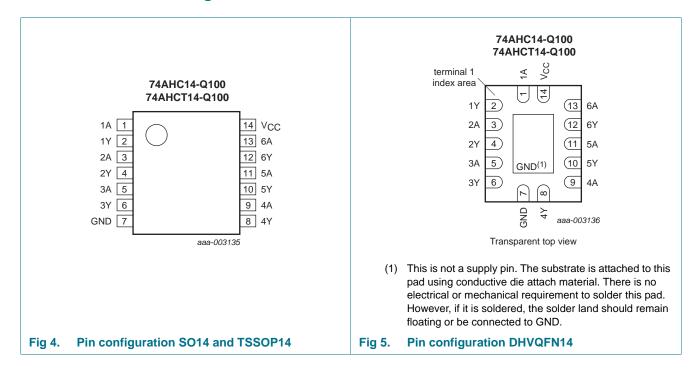
Type number	Package			
	Temperature range	Name	Description	Version
74AHC14-Q100		'		
74AHC14D-Q100	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74AHC14PW-Q100	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74AHC14BQ-Q100	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5\times3\times0.85$ mm	SOT762-1
74AHCT14-Q100				
74AHCT14D-Q100	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74AHCT14PW-Q100	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74AHCT14BQ-Q100	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5\times3\times0.85$ mm	SOT762-1

## 4. Functional diagram



## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1A	1	data input 1
1Y	2	data output 1
2A	3	data input 2
2Y	4	data output 2
3A	5	data input 3
3Y	6	data output 3
GND	7	ground (0 V)
4Y	8	data output 4
4A	9	data input 4
5Y	10	data output 5
5A	11	data input 5
6Y	12	data output 6
6A	13	data input 6
V <sub>CC</sub>	14	supply voltage

## 6. Functional description

Table 3. Function table[1]

Input	Output
nA	nY
L	Н
H	L

<sup>[1]</sup> H = HIGH voltage level;L = LOW voltage level.

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

		<b>3 7 7 3</b>		10	,
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 V$	<u>[1]</u> –20	-	mA
I <sub>OK</sub>	output clamping current	$V_{O}$ < $-0.5$ V or $V_{O}$ > $V_{CC}$ + $0.5$ V	<u>[1]</u> –20	+20	mA
I <sub>O</sub>	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-25	+25	mA
I <sub>CC</sub>	supply current		-	+75	mA
I <sub>GND</sub>	ground current		<b>–75</b>	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[2] -	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 8. Recommended operating conditions

Table 5. Operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
74AHC14-0	2100					
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	°C
74AHCT14	-Q100					
$V_{CC}$	supply voltage		4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	°C

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<sup>[2]</sup> For SO14 packages: above 70 °C the value of P<sub>tot</sub> derates linearly at 8 mW/K.
For TSSOP14 packages: above 60 °C the value of P<sub>tot</sub> derates linearly at 5.5 mW/K.
For DHVQFN14 packages: above 60 °C the value of P<sub>tot</sub> derates linearly at 4.5 mW/K.

## 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	–40 °C t	o +125 °C	Un
			Min	Тур	Max	Min	Max	Min	Max	
74AHC1	4-Q100									
V <sub>OH</sub>	HIGH-level	$V_I = V_{T+}$ or $V_{T-}$								
	output voltage	$I_{O} = -50 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -50 \mu A; V_{CC} = 3.0 V$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_{O} = -50 \mu A$ ; $V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -4.0 \text{ mA}$ ; $V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_O = -8.0 \text{ mA}$ ; $V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.80	-	3.70	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{T+}$ or $V_{T-}$								
	output voltage	$I_O = 50 \mu A; V_{CC} = 2.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 3.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
l <sub>l</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
lcc	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	2.0	-	20	-	40	μΑ
Cı	input capacitance		-	3	10	-	10	-	10	pF
Co	output capacitance		-	4	-	-	-	-	-	pF
74AHCT	14-Q100									
V <sub>OH</sub>	HIGH-level	$V_I = V_{T+}$ or $V_{T-}$								
	output voltage	$I_{O} = -50 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.80	-	3.70	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{T+}$ or $V_{T-}$								
	output voltage	$I_O = 50 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
I <sub>I</sub>	input leakage current	$V_{I} = 5.5 \text{ V or GND};$ $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	-	-	0.1	-	1.0	-	2.0	μΑ
lcc	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	2.0	-	20	-	40	μΑ
∆l <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$ ; other pins at $V_{CC}$ or GND; $I_O = 0 \text{ A}$ ; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	m
Cı	input capacitance		-	3	10	-	10	-	10	pF
Co	output capacitance		-	4	-	-	-	-	-	рF

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## 10. Dynamic characteristics

### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7.

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
			Mi	n Typ[1]	Max	Min	Max	Min	Max	
74AHC14	4-Q100									
t <sub>pd</sub>	propagation	nA to nY; see Figure 6	2]							
	delay	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$								
		C <sub>L</sub> = 15 pF	-	4.3	12.8	1.0	15.0	1.0	16.0	ns
		C <sub>L</sub> = 50 pF	-	5.8	16.3	1.0	18.0	1.0	20.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$								
		C <sub>L</sub> = 15 pF	-	3.2	8.6	1.0	10.0	1.0	11.0	ns
		$C_L = 50 pF$	-	4.2	10.6	1.0	12.0	1.0	13.5	ns
C <sub>PD</sub>	power dissipation capacitance	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$	3] -	10	-	-	-	-	-	pF
74AHCT	14-Q100									
t <sub>pd</sub>	propagation	nA to nY; see Figure 6	2]							
	delay	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$								
		C <sub>L</sub> = 15 pF	-	4.0	7.0	1.0	8.0	1.0	9.0	ns
		C <sub>L</sub> = 50 pF	-	5.4	8.0	1.0	9.0	1.0	10.0	ns
C <sub>PD</sub>	power dissipation capacitance	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$	<u>3]</u> _	12	-	-	-	-	-	pF

<sup>[1]</sup> Typical values are measured at nominal supply voltage ( $V_{CC}$  = 3.3 V and  $V_{CC}$  = 5.0 V).

$$P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o) \text{ where:}$$

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

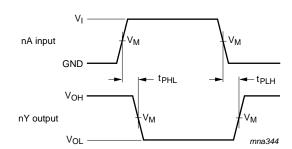
N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

<sup>[3]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

### 11. Waveforms



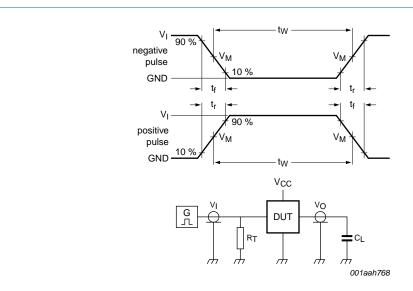
Measurement points are given in Table 8.

 $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

Fig 6. Input to output propagation delays

Table 8. Measurement points

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74AHC14-Q100	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
74AHCT14-Q100	1.5 V	0.5 × V <sub>CC</sub>



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator

C<sub>L</sub> = Load capacitance including jig and probe capacitance

### Fig 7. Test circuit for measuring switching times

Table 9. Test data

Туре	Input		Load	Test
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	
74AHC14-Q100	V <sub>CC</sub>	≤ 3.0 ns	50 pF, 15 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74AHCT14-Q100	3.0 V	≤ 3.0 ns	50 pF, 15 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

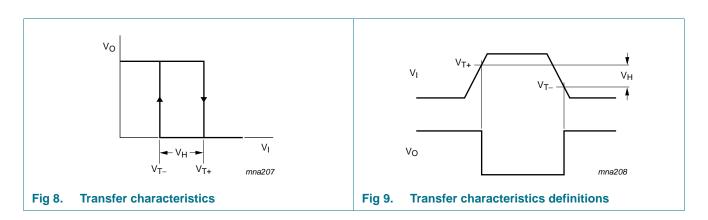
### 12. Transfer characteristics

#### Table 10. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); see Figure 8 and Figure 9.

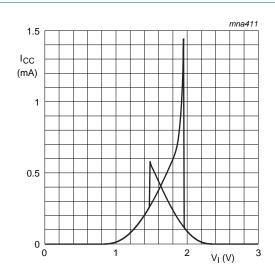
Symbol	Parameter	Conditions		25 °C		-40 °C 1	:o +85 °C	-40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHC1	4-Q100	'					•		•	
$V_{T+}$	positive-going	V <sub>CC</sub> = 3.0 V	-	-	2.2	-	2.2	-	2.2	V
	threshold voltage	V <sub>CC</sub> = 4.5 V	-	-	3.15	-	3.15	-	3.15	V
	voltage	V <sub>CC</sub> = 5.5 V	-	-	3.85	-	3.85	-	3.85	V
$V_{T-}$	negative-going	V <sub>CC</sub> = 3.0 V	0.9	-	-	0.9	-	0.9	-	V
	threshold voltage	V <sub>CC</sub> = 4.5 V	1.35	-	-	1.35	-	1.35	-	V
• • • • • • • • • • • • • • • • • • • •	voltage	V <sub>CC</sub> = 5.5 V	1.65	-	-	1.65	-	1.65	-	V
$V_{H}$	hysteresis	V <sub>CC</sub> = 3.0 V	0.3	-	1.2	0.3	1.2	0.25	1.2	V
	voltage	V <sub>CC</sub> = 4.5 V	0.4	-	1.4	0.4	1.4	0.35	1.4	V
		V <sub>CC</sub> = 5.5 V	0.5	-	1.6	0.5	1.6	0.45	1.6	V
74AHCT	14-Q100									
$V_{T+}$	positive-going	V <sub>CC</sub> = 4.5 V	-	-	1.9	-	1.9	-	1.9	V
	threshold voltage	V <sub>CC</sub> = 5.5 V	-	-	2.1	-	2.1	-	2.1	V
$V_{T-}$	negative-going	V <sub>CC</sub> = 4.5 V	0.5	-	-	0.5	-	0.5	-	V
threshold voltage	V <sub>CC</sub> = 5.5 V	0.6	-	-	0.6	-	0.6	-	V	
$V_{H}$	hysteresis	V <sub>CC</sub> = 4.5 V	0.4	-	1.4	0.4	1.4	0.35	1.4	V
	voltage	V <sub>CC</sub> = 5.5 V	0.4	-	1.5	0.4	1.5	0.35	1.5	V

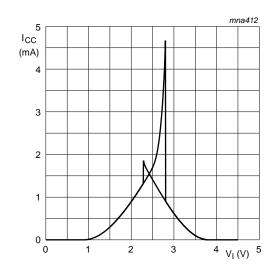
## 13. Transfer characteristics waveforms



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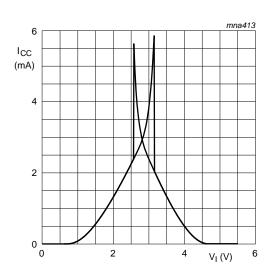
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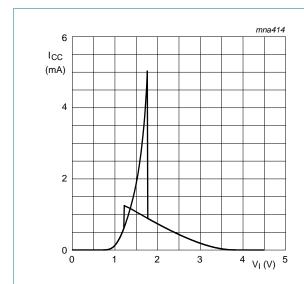
a.  $V_{CC} = 3.0 \text{ V}$ 

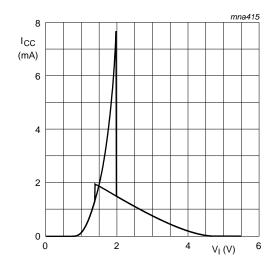




c.  $V_{CC} = 5.5 \text{ V}$ 

Fig 10. Typical 74AHC transfer characteristics



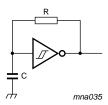


a.  $V_{CC} = 4.5 \text{ V}$ 

Fig 11. Typical 74AHCT transfer characteristics

b.  $V_{CC} = 5.5 \text{ V}$ 

## 14. Application information



For 74AHC14-Q100:  $f = \frac{1}{T} \approx \frac{1}{0.55 \times RC}$ 

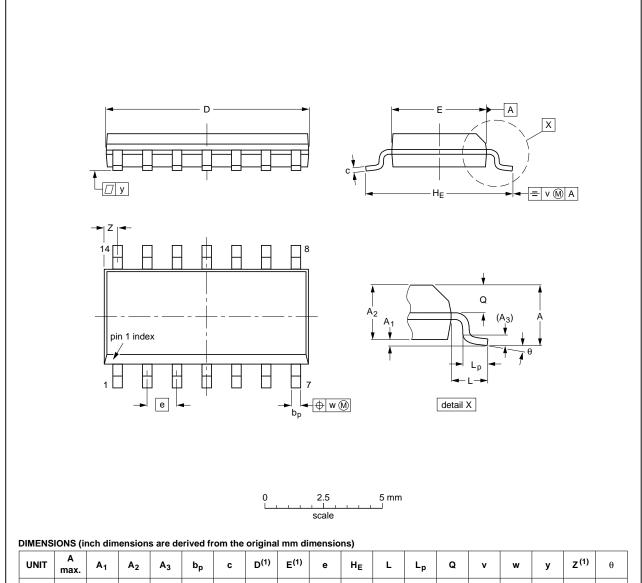
For 74AHCT14-Q100:  $f = \frac{I}{T} \approx \frac{I}{0.60 \times RC}$ 

Fig 12. Relaxation oscillator

## 15. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE						ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012				<del>99-12-27</del> 03-02-19

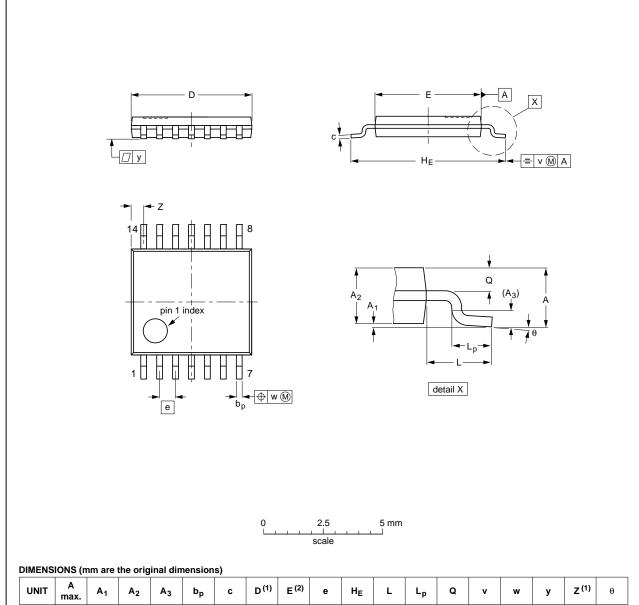
Fig 13. Package outline SOT108-1 (SO14)

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	C	D <sup>(1)</sup>	E <sup>(2)</sup>	e	HE	L	Lp	Q	٧	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT402-1		MO-153				<del>-99-12-27</del> 03-02-18	
					<b>)</b>	03-02-10	

Fig 14. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

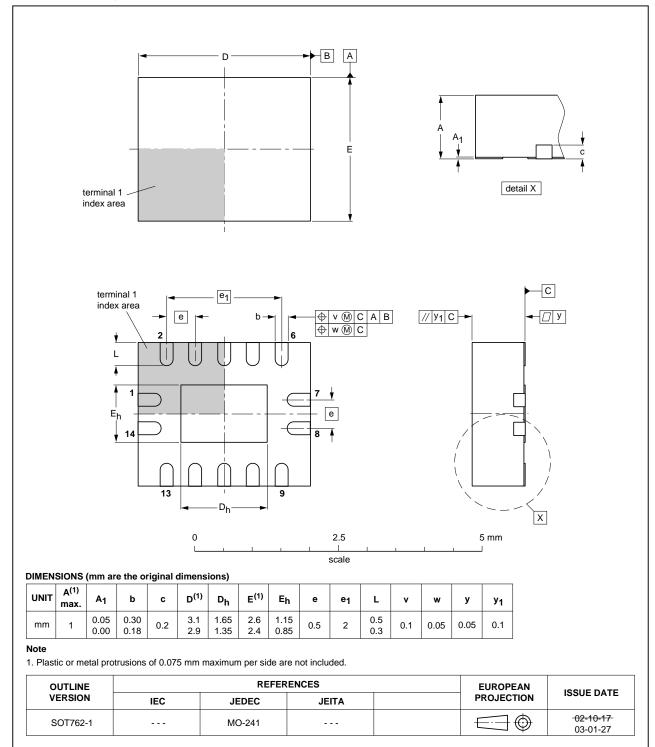


Fig 15. Package outline SOT762-1 (DHVQFN14)

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## 16. Abbreviations

### Table 11. Abbreviations

Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			
LSTTL	Low-power Schottky Transistor-Transistor Logic			
MM	Machine Model			
MIL	Military			

## 17. Revision history

### Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT14_Q100 v.1	20120709	Product data sheet	-	-

### 18. Legal information

### 18.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

### 18.2 Definitions

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## 74AHC14-Q100; 74AHCT14-Q100

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